## **BOSCO** Printed Circuits (Pty Ltd

Date: 25 Oct 2016

## **Manufacturing Capabilities**

## **Base Laminate Materials**

Standards:

IPC4101/21: Flammability UL 94 V-0

**RoHS Compliant** 



 Aluminium Substrate Pcb's (5052 Alu Alloy)

 Thickness
 Di-Electric Thickness
 Finished Copper (Cu) Thickness
 Thermal Conductivity W/m.K

 1.5mm
 100 μm
 35/00
 1.5 (± 0.2W/m\*k)

FR - 4 Epoxy Glass Laminate				
Thickness		Copper (Cu) Th		Tg °C
0.8mm	Base 35/00	Base 17/17	~	
Finished Cu Thickness	35/00	> 35/35	~	135 °C (±5)
1.0mm	Base 35/00	Base 17/17	* Base 70/70	
Finished Cu Thickness	35/00	> 35/35	> 90/90	135 °C (±5)
1.2mm	Base 35/00	Base 17/17	~	
Finished Cu Thickness	35/00	> 35/35	~	135 °C (±5)
* 1.55mm	Base 35/00	Base 17/17	~	
Finished Cu Thickness	35/00	> 35/35	~	135 °C (±5)
1.55mm	Base 70/00	70/70	~	
Finished Cu Thickness	70/70	> 90/90	~	135 °C (±5)
* 2.4mm	Base 35/35	~	~	
Finished Cu Thickness	> 55/55	~	~	135 °C (±5)
* 3.2mm	Base 35/35	~	~	
Finished Cu Thickness	> 55/55	~	~	135 °C (±5)

Note: Laminate Thickness Includes Copper Cladding.

D/S THP Pcb's: Base Copper will be Electroplated with an additional > 20 microns of copper each side.

For Pcb's with HAL Surface Finish - add 6-20 microns Tin on each side.

\* Subject to material stocks on hand

(Data Sheets for Aluminium Substrate and FR-4 Base Materials are availble on our Download Page on our website: www.bosco.co.za)

Maximum Pcb Size	
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Maximum Pcb Size	450 x 540mm
Maximum Pcb Size for Edge Connector Side	340mm
Maximimum Pcb Size for Bare Board Test	320 x 410mm

Minimum Finished Hole Diameter

0.4mm	For PTH - Up to 1.6mm max material thickness
0.3mm	For PTH - Up to 1.6mm max material thickness BUT subject to prior consultation with the Technical Director & BBT (Bare Board Test / Electrical Test is Mandatory)
0.6mm	PTH - Material thickness > 2.0mm
0.5mm	Non-PTH - Up to 3.2mm max material thickness

Tolerance of Finished Hole Diameters

- 0.00mm : + 0.05mm	<b>THP</b> Holes: 0.4 - 1.5mm Diameter
-0.00 mm : + 0.1mm	THP Holes: > 1.5mm Diameter
±0.05mm	Non-THP Holes: 0.5 - 1.6mm Diameter
±0.05mm	Non-THP Holes: > 1.6mm Diameter
±0.15mm	Routed Holes > 6.0mm

Date: 25 Oct 2016

Minimum Annular Ring	0.2mm		PTH Hole (Supported)			
William Allifulat King	0.3mm		Non-PTH Hole (Unsupported)			
Component Holes	0.25mm		PTH Hole for 70 μm Copper Thickness (Supported)			
	0.35mm		Non-PTH Hole for 70 μm Copper Thickness (Unsupported)			
Via Holes	0.15mm		to <b>IPC-6012B</b>	and IPC-A-600		
	Base Cu Thickness	Plated Cu Thickness	Finished Cu Thickness	Minimum Conductor (Trace) <b>Width</b>	Minimum Conductor (Trace) <b>Space</b>	
	17 μm	20 μm	37 μm	* 0.15mm (6 Mil)	* 0.15mm (6 Mil)	
Minimum Conductor (Track) Widths and Spacing for THP (Through Hole Plated Pcb's)	17 μm	20 μm	37 μm	0.2mm (8 Mil) Preferred	0.2mm (8 Mil) Preferred	
	35 μm	20 μm	55 μm	* 0.15mm (6 Mil)	* 0.15mm (6 Mil)	
	70 μm	20 μm	90 μm	0.2mm (8 Mil)	0.2mm (8 Mil)	
	* Subject to p	rior consultat	ion & BBT (Bar	e Board Test / Electric	al Test is Mandatory)	
	Base Cu Thickness	Plated Cu Thickness	Finished Cu Thickness	Minimum Conductor (Trace) Width	Minimum Conductor (Trace) <b>Space</b>	
	35 μm	~	35 μm	* 0.15mm (6 Mil)	0.15mm (6 Mil)	
Minimum Conductor (Track) Widths and Spacing for S/S (Single Sided Pcb's)	35 μm	~	35 μm	0.2mm (8 Mil) Preferred	0.2mm (8 Mil) Preferred	
	70 μm	~	70 μm	0.25mm (10 Mil)	0.25mm (10 Mil)	
	* Subject to prior consultation & BBT (Bare Board Test / Electrical Test is Mandatory)					
Land (Pad) Size <b>by Design</b>	Minimum Land (Pad) Size: <b>Component Hole Diameter</b> +0.4mm (i.e. Annular Ring 0.2mm / 10 Mil)					
Edita (1 day 5/20 by besign	Minumum Via Land (Pad) Size: <b>Via Hole Diameter</b> +0.3mm (i.e. Annular Ring 0.15mm / 6 Mil)					
Landless Hele to Condustor Spacing	0.2mm (8 Mil) Preferred					
Landless Hole to Conductor Spacing	0.175mm (7 Mil) Bare Board Test / Electrical Test is Mandatory					
	0.8 - 3.2mm Thickness Material			0.3mm Routed		
Minimum Distance of <b>ANY</b> Feature from Edges of the Routed Pcb including the Pcb Edges supplied	0.8 - 1.0mm Thickness Material			0.3mm V-Scored		
on V-Scored Panels	1.2 - 1.6mm Thickness Material			0.4mm V-Scored		
	2.4 & 3.2mm Thickness Material 0.6mm V-Scored				V-Scored	
Minimum Distance between Hole Walls	0.3mm [12 Mil]					
Minimum Distance between Holes and Pcb Edge / Panel Edge / Cut-outs (Excluding Edge Connectors)	1.0mm (0.3mm subject to Consultation with the Technical Director)					
Minimum Slot Width	1.0mm (0.8mm subject to Consultation with the Technical Director)					
Minimum Radius on internal Cut-outs	1.2mm (0.5mm Subject to Consultation with the Technical Director)					
Routing Diameter	2.4mm Standard					
Routing Tolerance	±0.1mm This applies to internal cutouts as well as for the CNC Routed Pcb Profile					

Date: 25 Oct 2016

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	Pattern Plated & THP Copper		20 μm Minimum (25μm Normal)		
Plating Thickness	Gold over Nickel Edge Con	Gold over Nickel Edge Connector		0 μm Normal)	
	Nickel (for Edge Connector	·)	2.5 μm		
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Surface Finishes	Solder Hot Air Level (HAL - Lead Free) 6 - 20μ ± 6 μm Minimum			± 6 μm Minimum	
	Curtain Coat Green				
Solder Resist (Photo-Imagable)	Screen Print Coat	Blue, Red, White, Black & Yellow			
Minimum Resist Thicknes	10 μm (Measured at Condu	10 μm (Measured at Conductor Knee)			
Minumum Resist Clearance around Lands / Pads	0.1mm	Min.	Solder Dam	0.2mm	
	Colours		White, Black		
Notation Ink (Legend, Ident)	Barcode & Number Serialization		Offered for White Only		
Conductive Carbon	Used for Keypads and other Carbon Contact purposes				
	Surface Resistance < 35 ohm / Square				
	Loop Resistance < 75 ohm				
	Min. Thickness	15 μ			
Temporary Solder Resist	(Peelable Blue Mask)  Note: Maximum Hole Diameter for Hole Tenting is 1.10mm			r Hole Tenting is	
	Minimum Pitch 0.3mm (12 Mil) (By Flying Probe : 0.15mm)				
Electrical Bare Board Testing (BBT)	U.SHIIII (12 IVIII) (By Flyling Flobe : U.13HIIII)				
	Test Voltage	Voltage 10 Volts			
	Isolation	2 Mohm	2 Mohm		
	Web Thickness	0.3mm	Min 0.27mr	n : Max 0.35mm	
V-Scoring	V-Score Angle	30°	ı		
(See our V-Score Specification: availble on our Download Page on our website: www.bosco.co.za)	Nominal Breaking Point Tolerance (on each side of the Pcb)		0.1 - 0.15mm	See our V-Score Specification VS001 Rev 1 2016	
	ISO 9001 : 2008				
	ANSI/IPC A 600				
Quality	(ANSI: American National Standards Institute)				
	(IPC: Institute for Interconnecting and Packaging Electronic Circuits)				
RoHS Compliance	All Pcb's manufactured and Supplied by Bosco are RoHS Compliant				
конs Compilance	All PCD's manufactured and	л эпрыед ру В	оѕсо аге конѕ сотр	lidilī	

Please consult with our Technical Director for any other special requirements or requests.

Non Standard Base Materials that are not available from Bosco but are available from our offshore Pcb Manufacturer

Laminates	Unit	Bosco Standard	Non-Standard - Available Offshore Only		
FR-4 Base Material:					
Available Thicknesses S/S & D/S	mm	0.8 (± 0.1); 1.0 (± 0.13); 1.2 (± 0.13); 1.55 (± 0.13); 2.4 (± 0.23); 3.2 (± 0.23)	0.35 (± 0.05)		
Available Finished Copper Thickness	μm	35 ; 70 ; 90	105		
Glass Transition Temperature - Tg	°C	135 (± 5)	170		
Aluminium Substrate Base Material:					
Available Thicknesses S/S	mm	1.5 (± 0.13)	1.0 (± 0.13) ; 2.0 (± 0.18)		
Available Thicknesses <b>D/S (Offshore Only)</b>	mm	~	0.8 (± 0.1); 1.0 (± 0.13); 1.5 (± 0.13); 2.0 (± 0.18)		
Available Finished Copper Thicknesses	μm	35	70		
Dielectric Thickness	μm	100	150		
Glass Transition Temperature - Tg	°C	≥ 110	≥ 110		
THERMAL Conductivity - W/m*K	W/m*K	1.5 (± 0.2 W/m*K)	2.0;3.0 (± 0.3 W/m*K)		